GAP PADS TCGF-SERIES 8,0 W/m*K



Thermally conductive gap fillers offer, besides excellent thermal properties, the ability to even out small, medium and big gaps and tolerances between the component (hot spot) and the cooling device.

Gap fillers are based on silicone and are filled with ceramic particles. They are tacky by nature. This can be single- or double sided. The use of an adhesive tape is not necessary in most cases. Anyway a single- or double-sided adhesive is available on request.

- Thermal conductivity: 8,0 W/m*K
- Available in 297x210 mm standard sheet size, other dimensions and die-cut parts on request
- Available in thicknesses from 0,5 to 10,0 mm
- Naturally both side tacky as standard, other options available
- Adhesive tape on request
- Based on silicone filled with ceramic particles











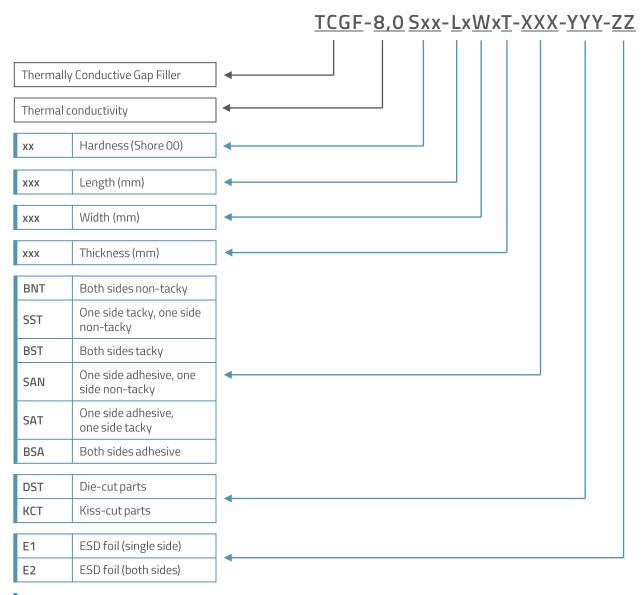


PRODUCT SPECIFICATIONS

PROPERTY	VALUE / TOLERANCE	TEST METHOD
THERMAL		
Thermal conductivity	8,0 W/m*K	ASTM E1530
ELECTRICAL		
Breakdown voltage	>6000V	ASTM D149
Volume resistivity	0,72*10 ¹³ Ω*cm	ASTM D257
PHYSICAL		
Composition	Silicone elastomer	-
Hardness	35 – 80 Shore 00 ± 10 %	ASTM D2240
Gravity	3,5 g/cm³	-
Thickness range	0,5 - 10,0 mm ± 10 %	ASTM D374
Standard sheet size	297x210mm	Caliper
Working temperature	-40 − 200 °C	-
Flammability rating	V-0	UL 94 E360243
Tensile strength	32Psi	ASTM D412
Dialectric constant	12,6 MHz	ASTM D150
Total mass loss (TML)	< 0,5% @ 24h /125°C vakuum	ASTM E595- 15



BUILDING AN ITEM NUMBER



Standard options

EXAMPLE

TCGF-8,0 S55-35x17x3-BST-DST-E1

Thermally conductive gap filler; thermal conductivity: 8,0 W/m*K; hardness: 55 Shore 00; size: 35x17 mm; thickness: 3 mm; both sides tacky; die-cut; ESD foil (single side)

TOLERANCES

THICKNESS		WIDTH AND HEIGTH	
0 – 0,50 mm	+/- 0,05 mm	0 – 50 mm	+/- 0,5 mm
0,60 – 15 mm	+/- 10%	> 50 mm	+/- 1,0 mm